

# 116-93-952-41-007000

### 116-93-952-41-007000 Information

Heisener.com	 116-93-952-41-007000 Mill-Max Manufacturing Corp. Connectors, Interconnects Sockets for ICs, Transistors CONN IC DIP SOCKET 52POS GOLD - For the pricing/inventory/lead time, please contact	
For Reference Only	us Website: https://www.heisener.com E-mail: salesdept@heisener.com	Request a Quote

## **Certified Quality**

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



## 116-93-952-41-007000 Specifications

Manufacturer Part Number116-93-952-41-007000ManufacturerMill-Max Manufacturing Corp.CategoryConnectors, InterconnectsBockets for ICs, TransistorsPackage-Series116TypeDIP, 0.9" (22.86mm) Row SpacingNumber of Positions or Pins (Grid)52 (2 x 26)Pitch - Mating0.100" (2.54mm)Contact Finish - MatingGoldContact Finish - Mating30µin (0.76µm)Contact Finish Thickness - MatingBeryllium CopperMounting TypeElevated, Open FrameFeaturesSolderTerminationSolderPitch - Post0.100" (2.54mm)Contact Finish - PostSolderContact Finish - PostSolderContact Finish - PostSolderContact Finish - PostOnto" (2.54mm)Contact Finish - PostOnto" (2.54mm)Contact Finish - PostOnto" (2.54mm)Contact Finish - PostSolderContact Finish - PostOnto" (2.54mm)Contact Finish - PostOnto" (2.54mm)Contact Finish - PostOnto (5.08µm)Contact Finish Thickness - PostBras AlloyContact Finish ThicknessBras AlloyContact Finish ThicknessBras AlloyContact Finish ThicknesSolderContact Finish ThicknesSolderContact Finish ThicknesSolder<			
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Housing Material Polycyclohexylenedimethylene Terephthalate (PCT), Polyester	Contact Finish Thickness - Post	200µin (5.08µm)	
	Contact Material - Post	Brass Alloy	
	Housing Material	Polycyclohexylenedimethylene Terephthalate (PCT), Polyester	
Operating Temperature $-55^{\circ}\text{C} \sim 125^{\circ}\text{C}$	Operating Temperature	-55°C ~ 125°C	
Report errors?			Report errors?

### 116-93-952-41-007000 Guarantees



Quality Guarantees

We provide 90 days warranty. \* If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



#### **Service Guarantees**

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

## 116-93-952-41-007000 Payment Methods





If you have any question about 116-93-952-41-007000, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com